## **SPECIFICATION FOR APPROVAL**

### 产品规格承认书 SMD POWER INDUCTOR

功率电感

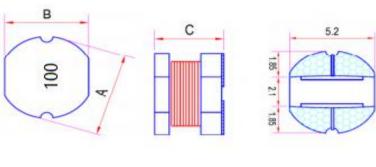
CUSTOMER.						
MODEL NO.		KCD52-220M				
CUSTOMER'S PAR	T NO.	SDR52-220M-LF				
LILE NO.		20-097				
DATE.		2020.2.24				
REVISION.		A/0				
	CUSTOMER APPROVE					
_						
D	ATE:					
		DRAWING				
	DRAWN BY	СНЕСК ВҮ	APPROVAL BY			
	ΛTE.					

## 常州银河创新磁电有限公司

CHANGZHOU GALAXY INNOVATION MAGNETOELECTRICITYCO. , LTD

# 常州银河创新磁电有限公司 CUSTOMER MODEL NO. KCD52-220M **REVISION** A/0 FILE NO. PART NO. DATE 2020.2.24 **REVISIONS** REW PROJECT CHANGE **DESCRIPTION** Date

#### 常州银河创新磁电有限公司 MODEL NO. KCD52-220M REVISION **CUSTOMER** A/0 FILE NO. PART NO. DATE 2020.2.24 1.PRODUCT DIMENSION **UNIT:mm** Α 5.8±0.3 В 5.2±0.3 В С 2.5±0.3 5.2



2.EL	ECTRICAL	REQUIREMENTS

ZIELEGTRIOAL REGUIREMEN			
PARAMETER	SPECIFICATION	CONDITION	TEST INSTRUMENTS
L( uH)	22±20%	100KHz/1.0V	MICROTEST 6377
DCR(Ω)	0.35MAX	At 25℃	TH2512A
I sat(A)	1.25A TYP 30%	100KHz/1.0V	MICROTEST 6377+6220

### 3.CHARACTERISTICS

- (1). All test data is based on 25℃ ambient.
- (3). DC current(A)that will cause L0 to drop approximately 10%Typ
- (4). Operating temperature range: -55℃~+125℃
- (5).The part temperature (ambient + temp rise)should not exceed 125℃ under worst case operating conditions. circuit design, component.PWB trace size and thickness,airflow and other cooling provision all affect the part temperature. Part temperature should be verified in the den application

### 4.SPECIAL REQUEST

(1)Lettering 100 on top of the body.

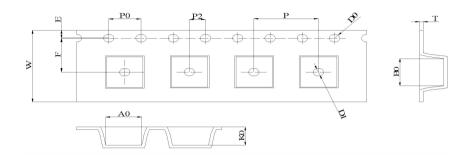
## 常州银河创新磁电有限公司 MODEL NO. **CUSTOMER** KCD52-220M **REVISION** A/0 FILE NO. PART NO. DATE 2020.2.24 **5.PRODUCT IDENTIFICATION** XXXX - XXX X X 1) 4 ①、 Product Symbol ②、 Dimensions 3, Inductance 4. Tolerance: M±20%, N±30%. 5 . Material **6.ELECTRICAL SCHEMATICS** 7.APPLICATION (1)Low profile, high current power supplies. (2)Battery powered devices. (3)DC/DC converters in distributed power systems. (5)DC/DC converters for field programmable gate array. 8.FEATURES (1)ROHS compliant. (2)Super low resistance,ultra high current rating. (3)high performance(I sat)realized by metal dust core. (4)Frequency Range:up to 1MHZ. 9.RECOMMENDED PCB LAYOUT Н s М

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CUSTOMER		MODEL NO.	KCD52-220M	REVISION	A/0
FILE NO.		PART NO.		DATE	2020.2.24
3					
项目Item	规格与 Specification a			测试方法Test Method	I
可焊性 Solder a bility test	沾锡面积不得小于95% Terminals area must h coverage		上锡升温曲线Solder heat proof: (1) 预热: 160±10℃持续90s Preheating: 160±10℃ for 90 seconds (2) 恒温时段: 245±5℃持续2±0.5s Retention time: 245±5℃ for 2±0.5 seconds		
振动测试 Vibration test	感值变化:不超过±5% 且无破裂等机械损伤产 Inductance change: W mechanical damage su	生 ithin±5% Without	(1) 振动频率(10Hz 55Hz 10Hz)60s为一个周期 Vibration frequency: (10Hz to 55Hz to 10Hz) in 60 seconds as a period (2) 振动时间 Vibration time:     三维正交坐标系每个方向振动(周期) 循环2小时 Period cycled for 2 hours in each of 3 mutual perpendicular directions (3) 振幅 Amplitude: 1.5 mm Max		
冲击测试 Shock test	感值变化:不超过±5% 且无破裂等机械损伤产 Inductance change: W mechanical damage su	生 ithin±5% Without	(1) 最大振幅 Peak val (2) 脉冲波长 Duration (3) 三维正交坐标系每 positive and negative directions	of pulse: 11ms 个方向正负方向冲击3	
冷热冲击 Thermal shock	感值变化:不超过±5% 且无破裂等机械损伤产生 Inductance change: Within±5% Without mechanical damage such as break		(1)重复以上100个循环Repeat 100 cycle as follow (-55±2℃,30±3分钟) 室温5分钟 (-55±2℃,30±3分钟) 室温5分钟 (-55±2℃,30±3 minutes) Room temperature,5 minutes (+125±2℃,30±3分钟) 室温5分钟 (+125±2℃,30±3 minutes) Room temperature,5 minutes (2)恢复: 测试于标准条件下恢复48+4/-0小时(参考注释1) Recovery:48+4/-0 hours of recovery under the standard condition after the test. (see Note1)		
耐高温测试 High temperature life test	感值变化:不超过±5% 且无破裂等机械损伤产生 Inductance change: Within±5% Without mechanical damage such as break		(1)环境条件: 85±2℃ Environment condition: 85±2℃ 应用电流: 额定电流 Applied current: Rated current (2)持续时间: 1000+4/-0 小时(参考注释1) Duration:1000+4/-0 hours (see Note1)		
耐湿测试 Humidity Resistance	感值变化:不超过±5% 且无破裂等机械损伤产生 Inductance change: Within±5% Without mechanical damage such as break		(1)环境条件: 60±2℃ Environment condition: 60±2℃ 湿度: 90~95% Humidity:90~95% 应用电流: 额定电流 Applied current: Rated current (2)持续时间: 1000+4/-0 小时(参考注释1) Duration:1000+4/-0 hours (see Note1)		
低温存放测试Low temperature life test	感值变化:不超过±5% 且无破裂等机械损伤产生 Inductance change: Within±5% Without mechanical damage such as break		(1)存储温度 Store temperature -55±2℃下存放 1000+4/-0 小时 -55±2℃for total 1000+4/-0 hours		
高温存放测试High temperature life test	感值变化:不超过±5% 且无破裂等机械损伤产 Inductance change: W mechanical damage su	ithin±5% Without	(1)存储温度 Store temperature +125±2℃下存放 1000+4/-0 小时 +125±2℃for total 1000+4/-0 hours		

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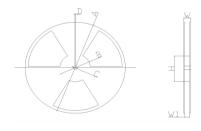
CUSTOMER	MODEL NO.	KCD52-220M	REVISION	A/0
FILE NO.	PART NO.		DATE	2020.2.24

## 12、包装 Packaging 12.1、尺寸 Dimensions 12.1.1 包装料带尺寸 Tape packaging dimensions



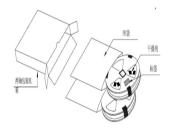
w	Α0	В0	K0	Р	F	Ш	D0	P0	Т
12.00	5.4	6.0	4.8	8.0	5.5	1.75	1.50	4.0	0.35
±0.30	±0.10	±0.10	±0.10	±0.10	±0.1	±0.10	±0.10	±0.10	±0.05

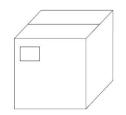
### 12.1.2 卷轴尺寸 Reel dimensions



项目	尺寸(mm)			
Α	330.0 ± 2.0			
В	100.0 ± 1.0			
С	13.0 ± 1.0			
D	1.9 ± 0.4			
W	17.5max			
W1	12.5max			

### 12.1.3 外箱尺寸Carton dimensions





项目	数量(PCS)		
1卷轴	2000		
1内箱	8000		
1外箱	12000		

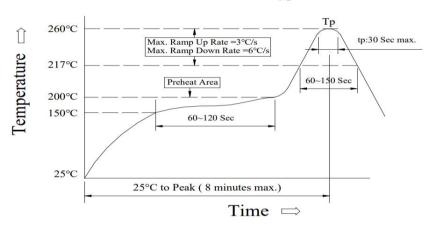
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FILE NO.	PART NO.		DATE	2020.2.24

### **Reflow curve**

### **※ Reflow Profile**

### Power Choke Coil Type



### 1. Reflow Soldering Method

Reflow Soldering	Tp:255~260°C	Max.30 seconds (tp)	
	217℃	60~150 seconds	
Pre-Heat	150 ~ 200°℃	60~120 seconds	
Time 25°C to peak temperature	8 minutes max.		

### 2. Soldering iron method : 350±5℃ Max.3 seconds.